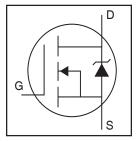


AUIRFS3107-7P

Features

- Advanced Process Technology
- Ultra Low On-Resistance
- Enhanced dV/dT and dI/dT capability
- 175°C Operating Temperature
- Fast Switching
- Repetitive Avalanche Allowed up to Tjmax
- Lead-Free, RoHS Compliant
- Automotive Qualified *

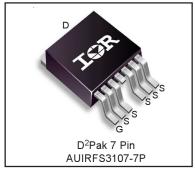


V _{DSS}	75V
R _{DS(on)} typ.	$\mathbf{2.1m}\Omega$
max.	2.6m $Ω$
L _D (Silicon Limited)	260A①
I _{D (Package Limited)}	240A

HEXFET® Power MOSFET

Description

Specifically designed for Automotive applications, this HEXFET® Power MOSFET utilizes the latest processing techniques to achieve extremely low on-resistance per silicon area. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating . These features combine to make this design an extremely efficient and reliable device for use in Automotive applications and a wide variety of other applications.



G	D	S
Gate	Drain	Source

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V (Silicon Limited)	260①	
I _D @ T _C = 100°C	Continuous Drain Current, VGS @ 10V (Silicon Limited)	190	A
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V (Package Limited)	240	
I _{DM}	Pulsed Drain Current ②	1060	
P _D @T _C = 25°C	Maximum Power Dissipation	370	W
	Linear Derating Factor	2.5	W/°C
V_{GS}	Gate-to-Source Voltage	± 20	V
E _{AS}	Single Pulse Avalanche Energy (Thermally Limited) 3	320	mJ
I _{AR}	Avalanche Current ②	See Fig. 14, 15, 22a, 22b	Α
E _{AR}	Repetitive Avalanche Energy ②		mJ
dv/dt	Peak Diode Recovery ④	13	V/ns
T _J	Operating Junction and	-55 to + 175	
T _{STG}	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds (1.6mm from case)	300	7

Thermal Resistance

i i i Ci i i i ai i	memai nesistance							
	Parameter	Тур.	Max.	Units				
$R_{\theta JC}$	Junction-to-Case 9 ®		0.40	°C/W				
$R_{\theta JA}$	Junction-to-Ambient (PCB Mount) ®		40					

HEXFET® is a registered trademark of International Rectifier.

^{*}Qualification standards can be found at http://www.irf.com/

Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	75			V	$V_{GS} = 0V, I_{D} = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.083		V/°C	Reference to 25°C, I _D = 5mA ²
R _{DS(on)}	Static Drain-to-Source On-Resistance		2.1	2.6	mΩ	$V_{GS} = 10V, I_D = 160A$ \odot
$V_{GS(th)}$	Gate Threshold Voltage	2.0		4.0	٧	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
gfs	Forward Transconductance	260			S	$V_{DS} = 25V, I_{D} = 160A$
R_G	Internal Gate Resistance		2.1	_	Ω	
I _{DSS}	Drain-to-Source Leakage Current			20	μA	$V_{DS} = 75V$, $V_{GS} = 0V$
				250		$V_{DS} = 75V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			100	nA	$V_{GS} = 20V$
	Gate-to-Source Reverse Leakage			-100		V _{GS} = -20V

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
Q_g	Total Gate Charge		160	240		I _D = 160A
Q_{gs}	Gate-to-Source Charge		38			$V_{DS} = 38V$
Q_{gd}	Gate-to-Drain ("Miller") Charge		57		nC	V _{GS} = 10V ⑤
Q _{sync}	Total Gate Charge Sync. (Q _g - Q _{gd})		103			$I_D = 160A, V_{DS} = 0V, V_{GS} = 10V$
t _{d(on)}	Turn-On Delay Time		17			$V_{DD} = 49V$
t _r	Rise Time		80			I _D = 160A
t _{d(off)}	Turn-Off Delay Time		100		ns	$R_G = 2.7\Omega$
t _f	Fall Time		64			V _{GS} = 10V ⑤
C _{iss}	Input Capacitance		9200			$V_{GS} = 0V$
C _{oss}	Output Capacitance		850		1	$V_{DS} = 50V$
C _{rss}	Reverse Transfer Capacitance		400		pF	f = 1.0MHz
C _{oss} eff. (ER)	Effective Output Capacitance (Energy Related)		1150		1	$V_{GS} = 0V$, $V_{DS} = 0V$ to $60V$ \bigcirc
C _{oss} eff. (TR)	Effective Output Capacitance (Time Related)®		1500		1	$V_{GS} = 0V$, $V_{DS} = 0V$ to $60V$ ©

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
I _S	Continuous Source Current			260①		MOSFET symbol
	(Body Diode)				Α	showing the
I _{SM}	Pulsed Source Current			1060	A	integral reverse
	(Body Diode) ②					p-n junction diode.
V_{SD}	Diode Forward Voltage			1.3	V	$T_J = 25^{\circ}C$, $I_S = 160A$, $V_{GS} = 0V$ \bigcirc
t _{rr}	Reverse Recovery Time		52			$T_J = 25$ °C $V_R = 64V$,
			63		ns	$T_{\rm J} = 125^{\circ}{\rm C}$ $I_{\rm F} = 160{\rm A}$
Q _{rr}	Reverse Recovery Charge		110		nC	$T_J = 25^{\circ}C$ di/dt = 100A/ μ s $^{\circ}$
			160			$T_J = 125^{\circ}C$
I _{RRM}	Reverse Recovery Current		3.8		Α	$T_J = 25^{\circ}C$
t _{on}	Forward Turn-On Time	Intrins	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)			

- \odot Calculated continuous current based on maximum allowable junction \odot Pulse width \leq 400 μ s; duty cycle \leq 2%. temperature. Bond wire current limit is 240A. Note that current limitations arising from heating of the device leads may occur with some lead mounting arrangements.
- 2 Repetitive rating; pulse width limited by max. junction
- R_{G} = 25 $\!\Omega$, I_{AS} = 160A, V_{GS} =10V. Part not recommended for use above this value.
- ④ $I_{SD} \le 160A$, di/dt ≤ 1420A/µs, $V_{DD} \le V_{(BR)DSS}$, $T_{J} \le 175$ °C.

- as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .
- O Coss eff. (ER) is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .
- ® When mounted on 1" square PCB (FR-4 or G-10 Material). For recom mended footprint and soldering echniques refer to application note #AN-994.
- $\ \ \,$ $\ \,$ $\ \ \,$ $\ \ \,$ $\ \ \,$ $\ \ \,$ $\ \ \,$ $\ \ \,$ $\ \ \,$ $\ \ \,$ $\ \,$ $\ \ \,$ $\ \ \,$ $\ \,$ $\ \ \,$ $\ \,$ $\ \ \,$ $\ \,$ $\ \ \,$ $\ \,$ $\ \,$ $\ \,$ $\ \,$ $\ \,$ $\ \,$ $\ \,$ $\ \,$ $\ \,$ $\ \,$ $\ \,$ $\ \,$ $\ \,$ $\ \,$ $\ \,$ $\ \,$ $\ \,$ $\ \,$
- 1 R_{θ JC} value shown is at time zero.

Qualification Information[†]

		Automotive (per AEC-Q101) ††				
		Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.				
Moisture Sensi	tivity Level	7L-D ² PAK MSL1				
	Machine Model		Class M4(+/- 800V) ^{†††} (per AEC-Q101-002)			
ESD	Human Body Model	Class H3A(+/- 6000V) ^{†††} (per AEC-Q101-001)				
	Charged Device Model	Class C5(+/- 2000V) ^{†††} (per AEC-Q101-005)				
RoHS Complian	nt	Yes				

- † Qualification standards can be found at International Rectifier's web site: http://www.irf.com/
- †† Exceptions (if any) to AEC-Q101 requirements are noted in the qualification report.
- ††† Highest passing voltage

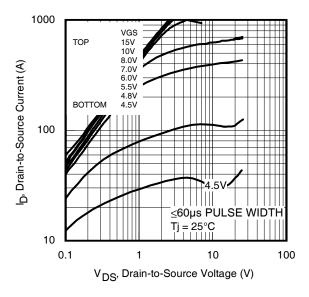


Fig 1. Typical Output Characteristics

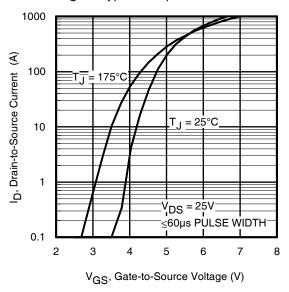


Fig 3. Typical Transfer Characteristics

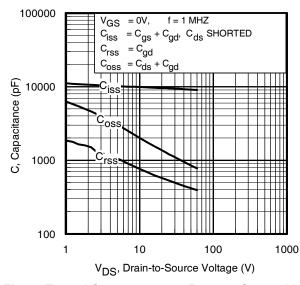


Fig 5. Typical Capacitance vs. Drain-to-Source Voltage

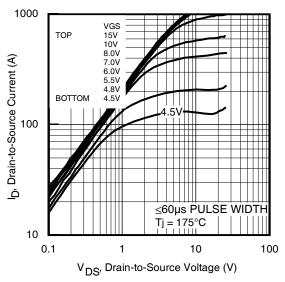


Fig 2. Typical Output Characteristics

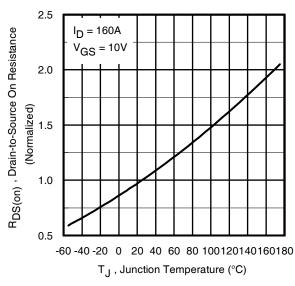


Fig 4. Normalized On-Resistance vs. Temperature

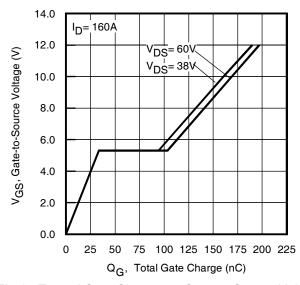


Fig 6. Typical Gate Charge vs. Gate-to-Source Voltage www.irf.com

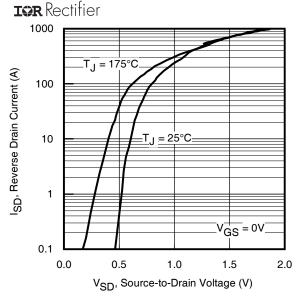


Fig 7. Typical Source-Drain Diode Forward Voltage

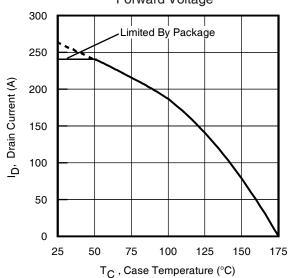


Fig 9. Maximum Drain Current vs. Case Temperature

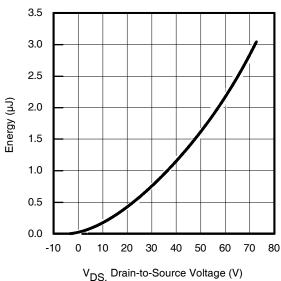


Fig 11. Typical C_{OSS} Stored Energy

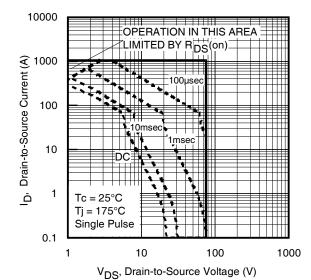


Fig 8. Maximum Safe Operating Area

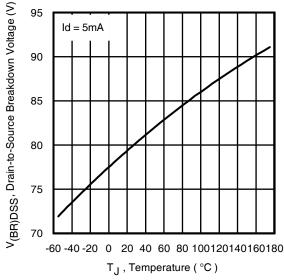


Fig 10. Drain-to-Source Breakdown Voltage

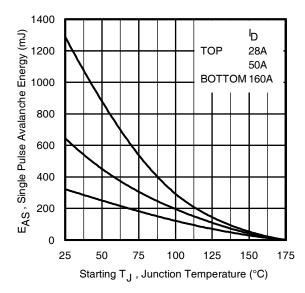


Fig 12. Maximum Avalanche Energy vs. DrainCurrent

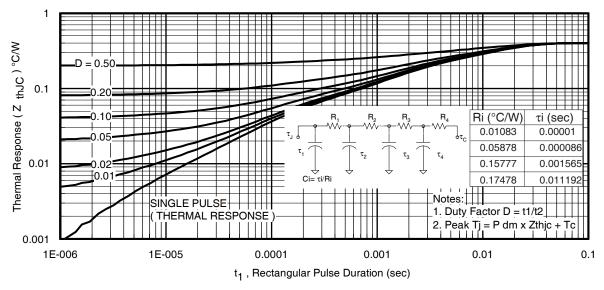


Fig 13. Maximum Effective Transient Thermal Impedance, Junction-to-Case

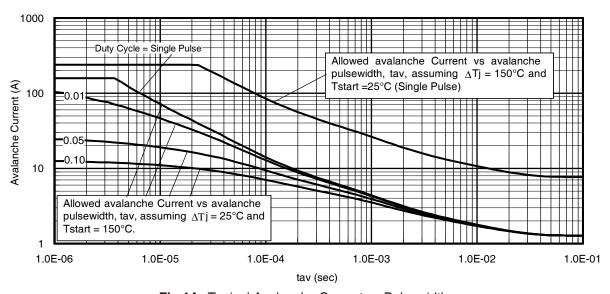


Fig 14. Typical Avalanche Current vs. Pulsewidth

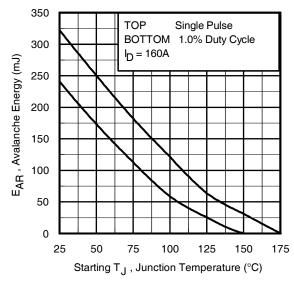


Fig 15. Maximum Avalanche Energy vs. Temperature

Notes on Repetitive Avalanche Curves , Figures 14, 15: (For further info, see AN-1005 at www.irf.com)

- 1. Avalanche failures assumption:
- Purely a thermal phenomenon and failure occurs at a temperature far in excess of T_{jmax} . This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long asT_{imax} is not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 22a, 22b.
- 4. $P_{D (ave)}$ = Average power dissipation per single avalanche pulse.
- BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. I_{av} = Allowable avalanche current.
- 7. ΔT = Allowable rise in junction temperature, not to exceed T_{jmax} (assumed as 25°C in Figure 14, 15).

t_{av =} Average time in avalanche.

D = Duty cycle in avalanche = $t_{av} \cdot f$

 $Z_{th,JC}(D, t_{av})$ = Transient thermal resistance, see Figures 13)

$$\begin{split} P_{D \text{ (ave)}} &= 1/2 \text{ (} 1.3 \cdot \text{BV} \cdot \text{I}_{av} \text{)} = \triangle \text{T/Z}_{thJC} \\ I_{av} &= 2\triangle \text{T/ [} 1.3 \cdot \text{BV} \cdot \text{Z}_{th} \text{]} \\ E_{AS \text{ (AR)}} &= P_{D \text{ (ave)}} \cdot t_{av} \end{split}$$

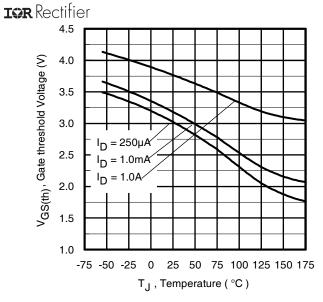


Fig 16. Threshold Voltage vs. Temperature

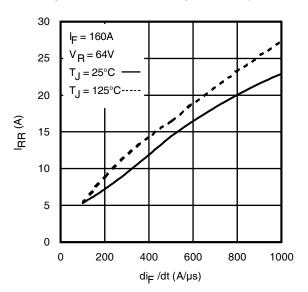


Fig. 18 - Typical Recovery Current vs. di_f/dt

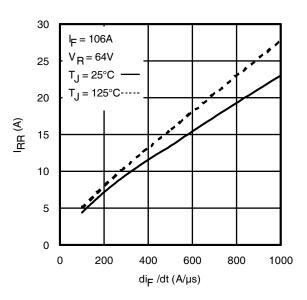


Fig. 17 - Typical Recovery Current vs. di_f/dt

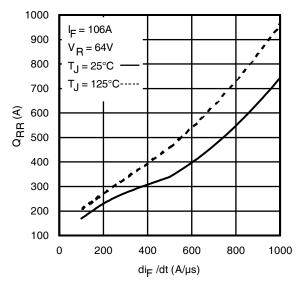


Fig. 19 - Typical Stored Charge vs. dif/dt

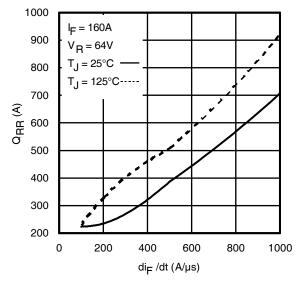
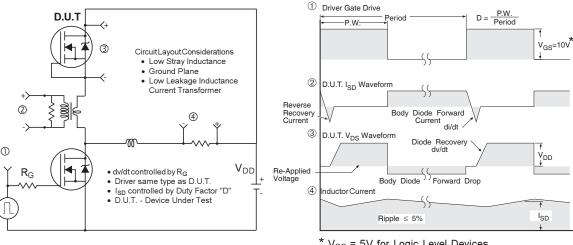


Fig. 20 - Typical Stored Charge vs. dif/dt



* V_{GS} = 5V for Logic Level Devices

Fig 21. Peak Diode Recovery dv/dt Test Circuit for N-Channel HEXFET® Power MOSFETs

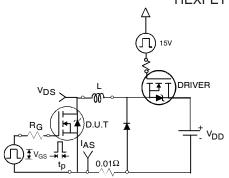


Fig 22a. Unclamped Inductive Test Circuit

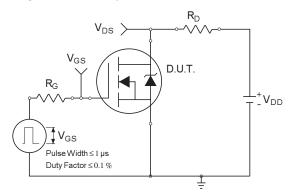


Fig 23a. Switching Time Test Circuit

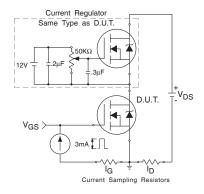


Fig 24a. Gate Charge Test Circuit

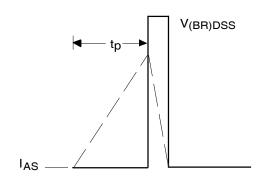


Fig 22b. Unclamped Inductive Waveforms

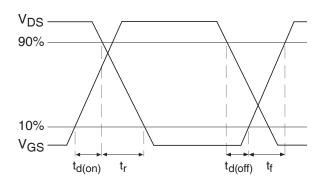


Fig 23b. Switching Time Waveforms

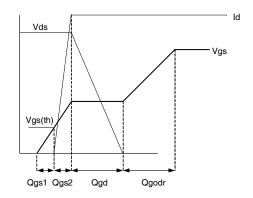
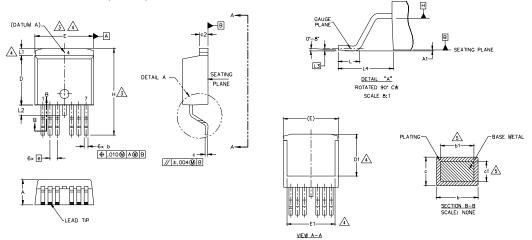


Fig 24b. Gate Charge Waveform

D²Pak - 7 Pin Package Outline

Dimensions are shown in millimeters (inches)

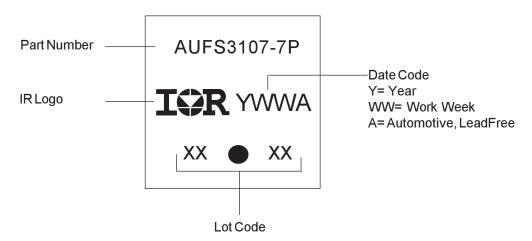


S Y M		Ň			
B	MILLIM	MILLIMETERS		HES	O T E S
Ľ	MIN.	MAX.	MIN.	MAX.	5
Α	4,06	4,83	.160	.190	
A1	-	0.254	-	.010	
b	0.51	0.99	.020	.036	
ь1	0.51	0.89	.020	.032	5
С	0.38	0.74	.015	.029	
c1	0.38	0,58	.015	.023	5
c2	1,14	1,65	.045	.065	
D	8.38	9.65	.330	.380	3
D1	6.86	-	.270		4
Ε	9.65	10.67	.380	.420	3,4
E1	6.22	-	.245		4
e	1.27	BSC	.050	BSC	
Н	14.61	15.88	.575	.625	
L	1.78	2.79	.070	.110	
L1	-	1.68	-	.066	4
L2	-	1.78	-	.070	
L3	0.25	BSC	.010	.010 BSC	
L4	4.78	5,28	.188	.208	

- NOTES:
- 1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M-1994
- 2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- SOURCES OF THE PLASTIC BODY AT DATUM H.

 2.127 [.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY AT DATUM H.
- 4. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSION E, L1, D1 & E1.
- 5. DIMENSION 61 AND c1 APPLY TO BASE METAL ONLY.
- 6. DATUM A & B TO BE DETERMINED AT DATUM PLANE H.
- 7. CONTROLLING DIMENSION: INCH.
- 8, OUTLINE CONFORMS TO JEDEC OUTLINE TO-263CB.

D²Pak - 7 Pin Part Marking Information



D²Pak - 7 Pin Tape and Reel

NOTES, TAPE & REEL, LABELLING:

- 1. TAPE AND REEL.
 - 1.1 REEL SIZE 13 INCH DIAMETER.
 - 1.2 EACH REEL CONTAINING BOO DEVICES.
 - 1.3 THERE SHALL BE A MINIMUM OF 42 SEALED POCKETS CONTAINED IN THE LEADER AND A MINIMUM OF 15 SEALED POCKETS IN THE TRAILER.
 - 1.4 PEEL STRENGTH MUST CONFORM TO THE SPEC. NO. 71-9667.
 - 1.5 PART ORIENTATION SHALL BE AS SHOWN BELOW.
 - 1.6 REEL MAY CONTAIN A MAXIMUM OF TWO UNIQUE LOT CODE/DATE CODE COMBINATIONS.

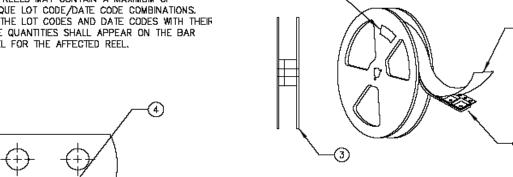
 REWORKED REELS MAY CONTAIN A MAXIMUM OF THREE UNIQUE LOT CODE/DATE CODE COMBINATIONS.

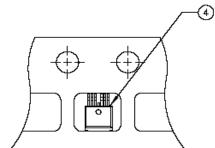
 HOWEVER, THE LOT CODES AND DATE CODES WITH THEIR RESPECTIVE QUANTITIES SHALL APPEAR ON THE BAR CODE LABEL FOR THE AFFECTED REEL.

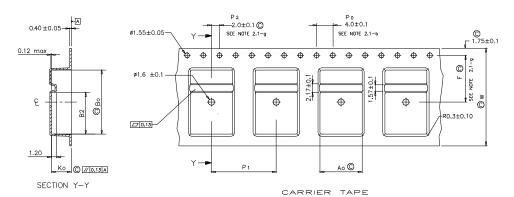
- 2. LABELLING (REEL AND SHIPPING BAG).
 - 2.1 CUST. PART NUMBER (BAR CODE): IRF2804S-7PTRL
 - 2.2 CUST, PART NUMBER (TEXT CODE); IRF2804S-7PTRL
 - 2.3 I.R. PART NUMBER: IRF28045-7PTRL
 - 2.4 QUANTITY:
 - 2.5 VENDOR CODE: IR

LABEL

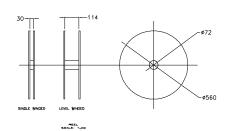
- 2.6 LOT CODE:
- 2.7 DATE CODE:







Ao	10.80	+/- 0.1
Во	16.00	+/- 0.1
B2	10.35	+/- 0.1
Ko	4.90	+/- 0.1
F	11.50	+/- 0.1
P ₁	16.00	+/- 0.1
W	24.00	+/- 0.1



LONG	UNITS
130	METERS/REEL

Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

Ordering Information

Base part	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRFS3107-7P	D2Pak -7Pin	Tube	75	AUIRFS3107-7P
		Tape and Reel Left	800	AUIRFS3107-7TRL
		Tape and Reel Right	800	AUIRFS3107-7TRR

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IR warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with IR's standard warranty. Testing and other quality control techniques are used to the extent IR deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

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